

# FUJI POWER MOSFET

## Super FAP-G Series

### N-CHANNEL SILICON POWER MOSFET

#### ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

#### ■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

#### ■ Maximum ratings and characteristic

##### (TC=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit	
Drain-source voltage	VDS	250	V	
	VDSX *5	220	V	
Continuous drain current	ID	±10	A	
Pulsed drain current	ID(puls)	±40	A	
Gate-source voltage	VGS	±30	V	
Non-repetitive Avalanche current	IAS *2	10	A	
Maximum Avalanche Energy	EAS *1	182	mJ	
Maximum Drain-Source dV/dt	dVDS/dt *4	20	kV/μs	
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs	
Max. power dissipation	Pd	Ta=25°C Tc=25°C	2.16	W
			25	
Operating and storage temperature range	Tch	+150	°C	
	Tstg	-55 to +150	°C	
Isolation voltage	VISO	2	kVrms	

\*1 L=3.05mH, Vcc=48V    \*2 Tch≤150°C    \*3 IF≤ -ID, -di/dt=50A/μs, Vcc≤BVDS, Tch≤150°C

\*4 Vds ≤ 250V    \*5 Vgs=-30V    \*6 t=60sec f=60Hz

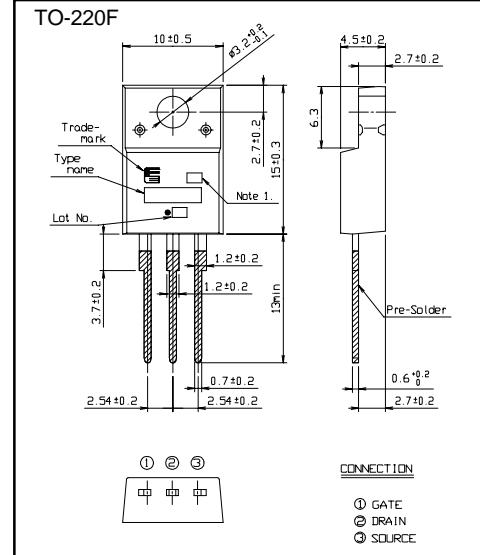
##### ● Electrical characteristics (TC = 25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	ID= 250μA VGS=0V	250			V
Gate threshold voltage	VGS(th)	ID= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	IDSS	VDS=250V VGS=0V	Tch=25°C	25	250	μA
		VDS=200V VGS=0V				
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	ID=5A VGS=10V		200	260	mΩ
Forward transconductance	gfs	ID=5A VDS=25V	5	10		S
Input capacitance	Ciss	VDS=75V VGS=0V f=1MHz	785 88 4	1178 132 6		pF
Output capacitance	Coss					
Reverse transfer capacitance	Crss					
Turn-on time ton	td(on)	Vcc=48V Id=5A VGS=10V RGS=10 Ω	12 2.7 22 7.4	18 4.1 33 11.1		ns
	tr					
Turn-off time toff	td(off)					
	tf					
Total Gate Charge	QG	Vcc=125V Id=10A VGS=10V	21 8 5	31.5 12 7.5		nC
Gate-Source Charge	QGS					
Gate-Drain Charge	QGD					
Avalanche capability	IAV	L=100μH Tch=25°C	10			A
Diode forward on-voltage	VSD	IF=10A VGS=0V Tch=25°C		1.10	1.65	V
Reverse recovery time	trr	IF=10A VGS=0V -di/dt=100A/μs Tch=25°C	0.155 1.05			μs
Reverse recovery charge	Qrr					

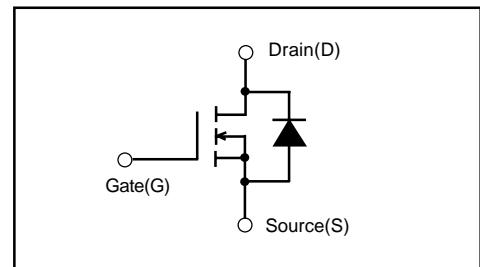
##### ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			5.0	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

#### ■ Outline Drawings (mm)



#### ■ Equivalent circuit schematic



## ■ Characteristics

